

## C1210H104J5GAF7282

SMD Indust COG HT200C, Ceramic, 0.1 uF, 5%, 50 VDC, COG, SMD, MLCC, High Temperature, Ultra-Stable, Low Loss, 1210, 1.5 mm



Click here for the 3D model.

General Information	
Series	SMD Indust COG HT200C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable, Low Loss
Features	High Temp, Ultra-Stable, Low Loss
RoHS	Yes
Termination	Gold
Marking	No
AEC-Q200	No
Typical Component Weight	40 mg
Miscellaneous	Moisture Sensitive Packaging. Gold (Au) 30 - 70 micro inches.
Shelf Life	78 Weeks
MSL	1

Chip Size 1210   L 3.2mm +/-0.2mm   W 2.5mm +/-0.2mm   T 1.25mm +/-0.15mm   S 1.5mm MIN	Dimensions	
W 2.5mm +/-0.2mm   T 1.25mm +/-0.15mm	Chip Size	1210
T 1.25mm +/-0.15mm	L	3.2mm +/-0.2mm
· · · · · · · · · · · · · · · · · · ·	W	2.5mm +/-0.2mm
S 1.5mm MIN	т	1.25mm +/-0.15mm
	S	1.5mm MIN
B 0.5mm +/-0.25mm	В	0.5mm +/-0.25mm

Packaging Specifications	
Packaging	Waffle, Tray
Packaging Quantity	80

Specifications	
Capacitance	0.1 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	5%
Voltage DC	50 VDC
Dielectric Withstanding Voltage	125 VDC
Temperature Range	-55/+200°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	10 GOhms

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